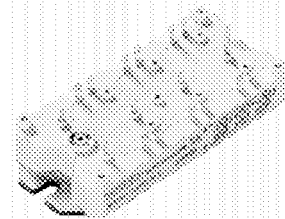
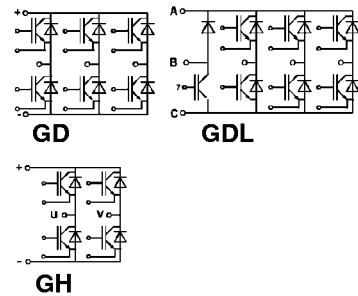


**SEMITRANS®  
Superfast NPT-IGBT  
Modules**

**SKM 50 GD 063 DL  
SKM 50 GDL 063 D\*\*)  
SKM 50 GH 063 DL \*\*\*)**



**SIXPACK / 7-Pack\*\*) / 4-Pack\*\*\*)**



**Features**

- N channel, homogeneous Silicon structure (NPT- Non punch-through IGBT)
- Low tail current with low temperature dependence
- High short circuit capability, self limiting if term. G is clamped to E
- Pos. temp.-coeff. of  $V_{CEsat}$
- 50 % less turn off losses <sup>9)</sup>
- 30 % less short circuit current <sup>9)</sup>
- Very low  $C_{ies}$ ,  $C_{oes}$ ,  $C_{res}$  <sup>9)</sup>
- Latch-up free
- Fast & soft inverse CAL diodes <sup>8)</sup>
- Isolated copper baseplate using DCB Direct Copper Bonding Technology without hard mould
- Large clearance (9 mm) and creepage distances (13 mm)

**Typical Applications**

- Switching (not for linear use)
- Switched mode power supplies
- UPS
- Three phase inverters for servo / AC motor speed control
- Pulse frequencies also > 10 kHz

**Cases and mech. data → B 6 – 14**

Absolute Maximum Ratings		Values	Units
Symbol	Conditions <sup>1)</sup>		
$V_{CES}$		600	V
$V_{CGR}$	$R_{GE} = 20 \text{ k}\Omega$	600	V
$I_C$	$T_{case} = 25/75 \text{ }^\circ\text{C}$	70 / 50	A
$I_{CM}$	$T_{case} = 25/75 \text{ }^\circ\text{C}; t_p = 1 \text{ ms}$	140 / 100	A
$V_{GES}$		$\pm 20$	V
$P_{tot}$	per IGBT, $T_{case} = 25 \text{ }^\circ\text{C}$	250	W
$T_j, (T_{stg})$		-40 ... +150 (125)	$^\circ\text{C}$
$V_{isol}$	AC, 1 min.	2500	V
humidity	DIN 40040	Class F	
climate	DIN IEC 68 T.1	40/125/56	
<b>Inverse Diode</b>			
$I_F = -I_C$	$T_{case} = 25/80 \text{ }^\circ\text{C}$	75 / 50	A
$I_{FM} = -I_{CM}$	$T_{case} = 25/80 \text{ }^\circ\text{C}; t_p = 1 \text{ ms}$	140 / 100	A
$I_{FSM}$	$t_p = 10 \text{ ms}; \text{sin.}; T_j = 150 \text{ }^\circ\text{C}$	440	A
$I^2t$	$t_p = 10 \text{ ms}; T_j = 150 \text{ }^\circ\text{C}$	970	$\text{A}^2\text{s}$

Characteristics		min.	typ.	max.	Units
Symbol	Conditions <sup>1)</sup>				
$V_{(BR)CES}$	$V_{GE} = 0, I_C = 1,5 \text{ mA}$	$\geq V_{CES}$	-	-	V
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 1 \text{ mA}$	4,5	5,5	6,5	V
$I_{CES}$	$V_{GE} = 0 \left. \begin{array}{l} T_j = 25 \text{ }^\circ\text{C} \\ T_j = 125 \text{ }^\circ\text{C} \end{array} \right\}$	-	0,1	1,5	mA
		-	3	-	mA
$I_{GES}$	$V_{GE} = 20 \text{ V}, V_{CE} = 0$	-	-	100	nA
$V_{CEsat}$	$I_C = 30 \text{ A} \left. \begin{array}{l} V_{GE} = 15 \text{ V}; \\ T_j = 25 (125) \text{ }^\circ\text{C} \end{array} \right\}$	-	1,8(2,0)	-	V
$V_{CEsat}$	$I_C = 50 \text{ A} \left. \begin{array}{l} V_{GE} = 15 \text{ V}; \\ T_j = 25 (125) \text{ }^\circ\text{C} \end{array} \right\}$	-	2,1(2,4)	2,5(2,8)	V
$g_{fs}$	$V_{CE} = 20 \text{ V}, I_C = 50 \text{ A}$	20	-	-	S
$C_{CHC}$	per IGBT	-	-	350	pF
$C_{ies}$	$V_{GE} = 0$	-	2800	-	pF
$C_{oes}$	$V_{CE} = 25 \text{ V}$	-	300	-	pF
$C_{res}$	$f = 1 \text{ MHz}$	-	200	-	pF
$L_{CE}$		-	-	60	nH
$t_{d(on)}$	$V_{CC} = 300 \text{ V}$ $V_{GE} = -15 \text{ V} / +15 \text{ V}^{3)}$ $I_C = 50 \text{ A, ind. load}$ $R_{Gon} = R_{Goff} = 22 \text{ }^\circ\Omega$ $T_j = 125 \text{ }^\circ\text{C}$	-	50	-	ns
$t_r$		-	40	-	ns
$t_{d(off)}$		-	300	-	ns
$t_f$		-	30	-	ns
$E_{on}$		-	2,5	-	mWs
$E_{off}$		-	1,8	-	mWs
<b>Inverse Diode <sup>8)</sup></b>					
$V_F = V_{EC}$	$I_F = 50 \text{ A} \left. \begin{array}{l} V_{GE} = 0 \text{ V}; \\ T_j = 25 (125 \text{ }^\circ\text{C}) \end{array} \right\}$	-	1,45(1,35)	1,7	V
$V_{TO}$	$T_j = 125 \text{ }^\circ\text{C}$	-	-	0,9	V
$r_t$	$T_j = 125 \text{ }^\circ\text{C}$	-	10	15	$\text{m}\Omega$
$I_{RRM}$	$I_F = 50 \text{ A}; T_j = 125 \text{ }^\circ\text{C}^{2)}$	-	31	-	A
$Q_{rr}$	$I_F = 50 \text{ A}; T_j = 125 \text{ }^\circ\text{C}^{2)}$	-	3,2	-	$\mu\text{C}$
<b>Thermal characteristics</b>					
$R_{thjc}$	per IGBT	-	-	0,5	$^\circ\text{C/W}$
$R_{thjc}$	per diode	-	-	1,0	$^\circ\text{C/W}$
$R_{thch}$	per module	-	-	0,05	$^\circ\text{C/W}$

Diagrams Fig. 1 to 24 of type SKM 50GB063D apply

\*\*\*) 7-pack = three phase inverter plus brake chopper

\*\*\*\*) 4-pack, branch W left off

<sup>1)</sup>  $T_{case} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

<sup>2)</sup>  $I_F = -I_C, V_R = 300 \text{ V}, -di_F/dt = 800 \text{ A}/\mu\text{s}, V_{GE} = 0 \text{ V}$

<sup>3)</sup> Use  $V_{GEoff} = -5 \dots -15 \text{ V}$

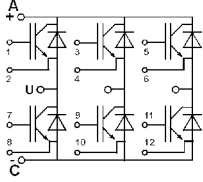
<sup>8)</sup> CAL = Controlled Axial Lifetime Technology

<sup>9)</sup> Compared to PT-IGBT

## SKM 50 GD 063 DL...

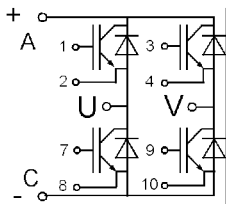
### SEMITRANS® Sixpack

Case D 68  
UL Recognized  
File no. E 63 532  
**SKM 50 GD 063 DL**

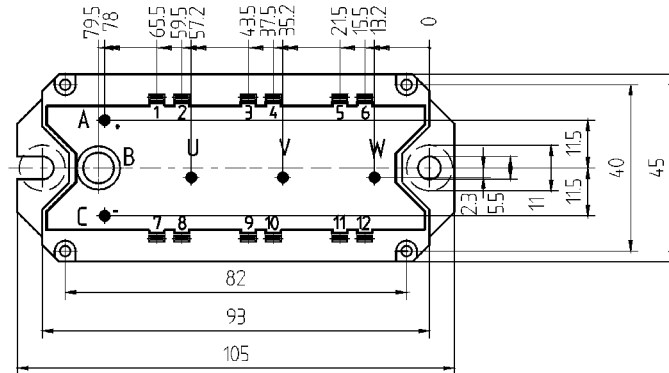
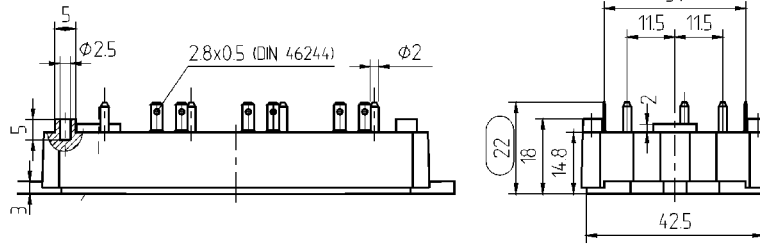


### SKM 50 GH 063 DL

Case D77 (= D68 without terminal W)



CASED68

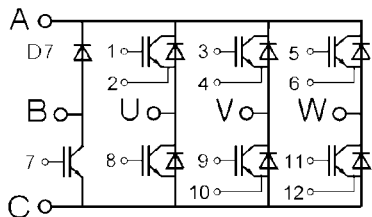


### SEMITRANS® Sevenpack

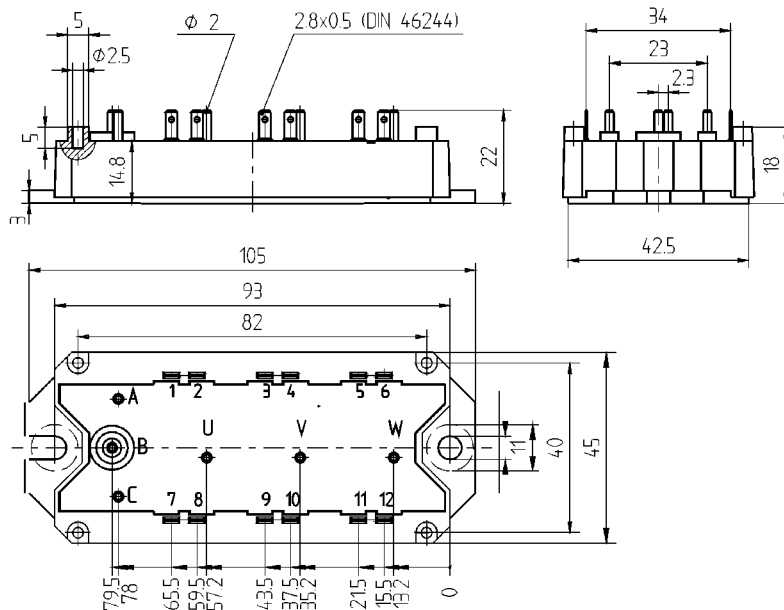
Case D 73  
UL Recognized  
File no. E 63 532

### SKM 50 GDL 063 D

0000DL



CASED73



Dimensions in mm

Case outlines and circuit diagrams

Mechanical Data		Values			Units
Symbol	Conditions	min.	typ.	max.	
M <sub>1</sub>	to heatsink, SI Units (M5)	4	—	5	Nm
	to heatsink, US Units	35	—	44	lb.in.
a		—	—	5x9,81	m/s <sup>2</sup>
w		—	—	175	g

**This is an electrostatic discharge sensitive device (ESDS). Please observe the international standard IEC 747-1, Chapter IX.**

Two devices are supplied in one SEMIBOX A.  
Larger packing units (10 or 20 pieces) are used if suitable SEMIBOX → page C - 1.

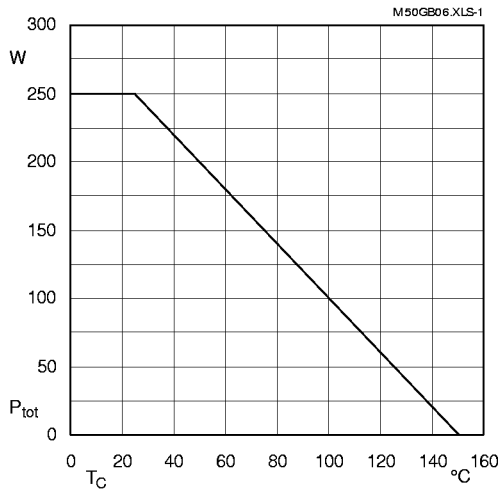


Fig. 1 Rated power dissipation  $P_{tot} = f(T_C)$

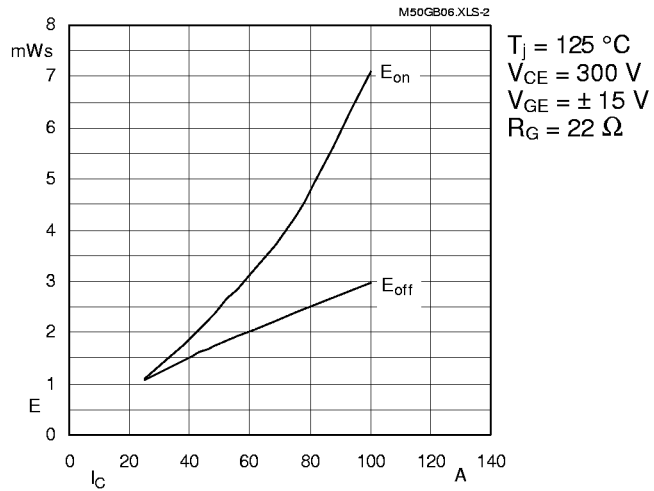


Fig. 2 Turn-on /-off energy  $= f(I_C)$

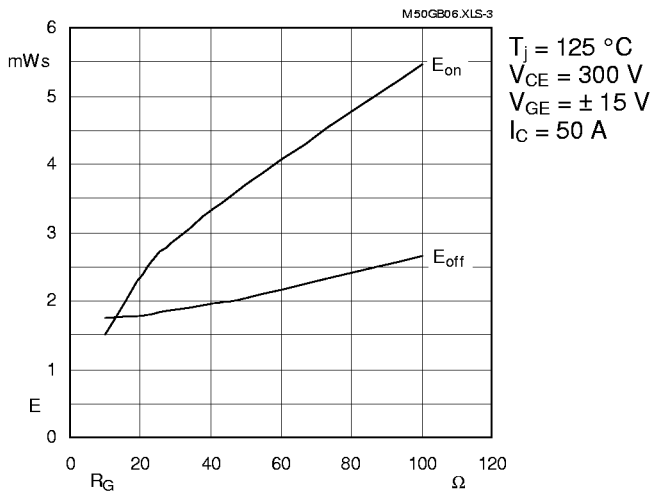


Fig. 3 Turn-on /-off energy  $= f(R_G)$

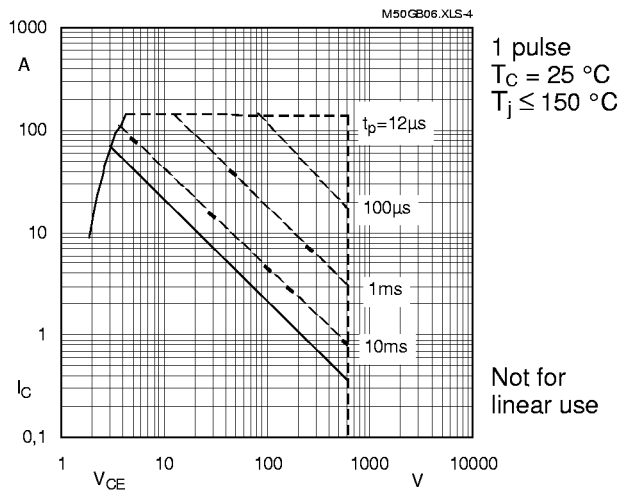


Fig. 4 Maximum safe operating area (SOA)  $I_C = f(V_{CE})$

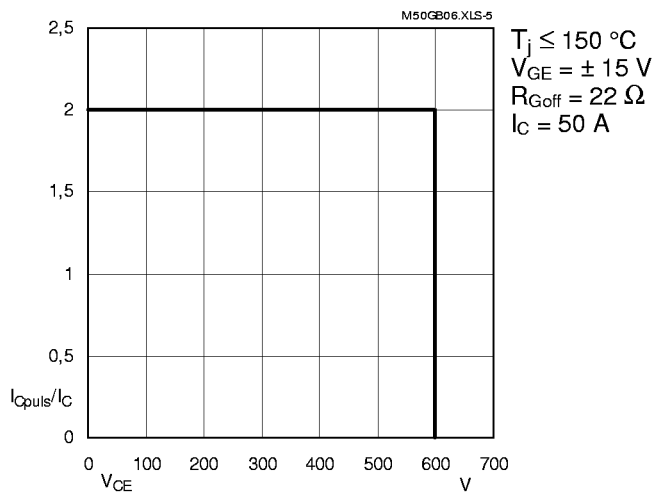


Fig. 5 Turn-off safe operating area (RBSOA)

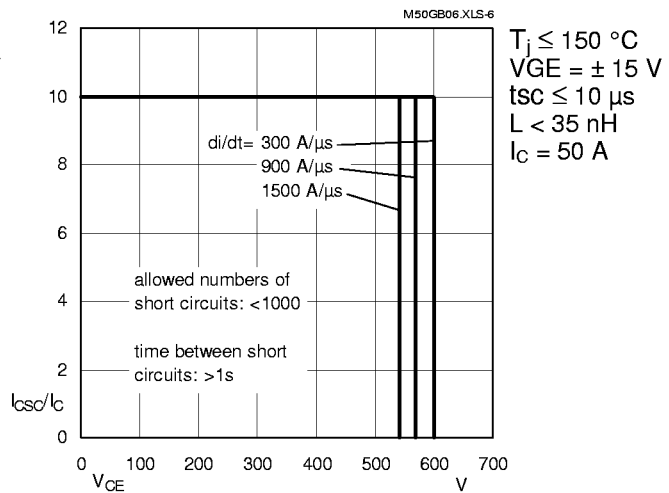


Fig. 6 Safe operating area at short circuit  $I_C = f(V_{CE})$

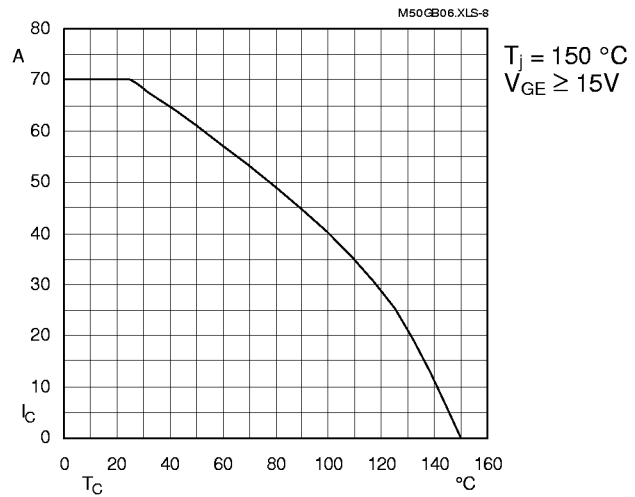


Fig. 8 Rated current vs. temperature  $I_C = f(T_C)$

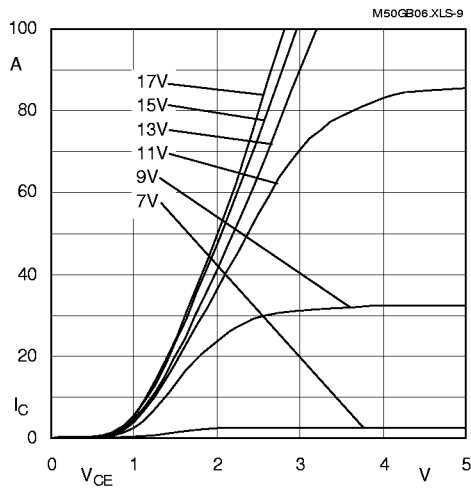


Fig. 9 Typ. output characteristic,  $t_p = 250 \mu s$ ;  $T_j = 25 \text{ }^\circ\text{C}$

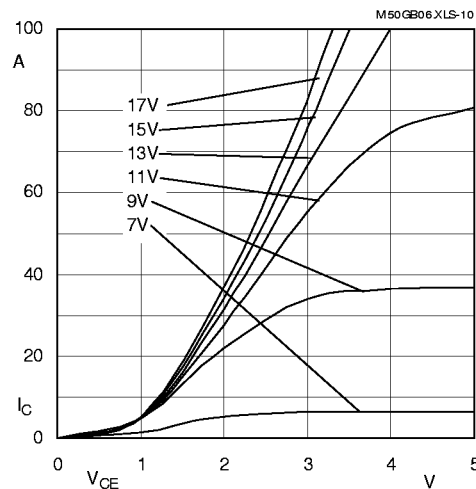


Fig. 10 Typ. output characteristic,  $t_p = 250 \mu s$ ;  $T_j = 125 \text{ }^\circ\text{C}$

$$P_{\text{cond}(t)} = V_{\text{CEsat}(t)} \cdot I_{\text{C}(t)}$$

$$V_{\text{CEsat}(t)} = V_{\text{CE(TO)(Tj)}} + r_{\text{CE(Tj)}} \cdot I_{\text{C}(t)}$$

$$V_{\text{CE(TO)(Tj)}} \leq 1,2 - 0,001 (T_j - 25) \text{ [V]}$$

$$\text{typ.: } r_{\text{CE(Tj)}} = 0,018 + 0,00008 (T_j - 25) \text{ [\Omega]}$$

$$\text{max.: } r_{\text{CE(Tj)}} = 0,026 + 0,00008 (T_j - 25) \text{ [\Omega]}$$

$$\text{valid for } V_{\text{GE}} = +15 \begin{matrix} +2 \\ -1 \end{matrix} \text{ [V]; } I_{\text{C}} \geq 0,3 I_{\text{Cnom}}$$

Fig. 11 Saturation characteristic (IGBT)  
Calculation elements and equations

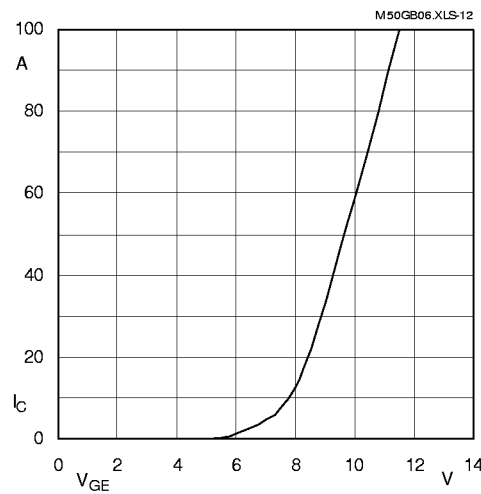


Fig. 12 Typ. transfer characteristic,  $t_p = 80 \mu s$ ;  $V_{\text{CE}} = 20 \text{ V}$

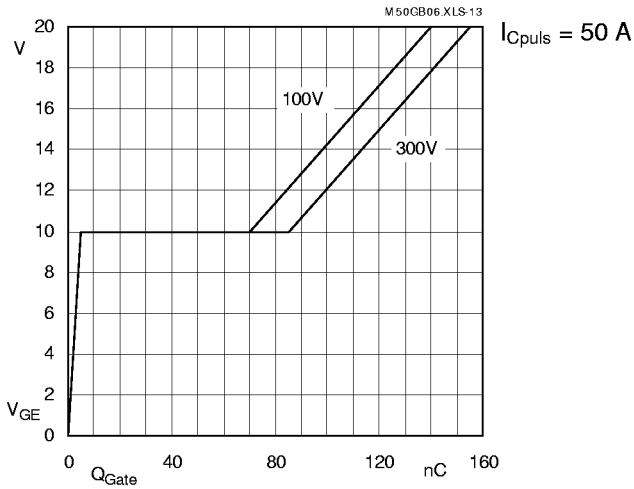


Fig. 13 Typ. gate charge characteristic

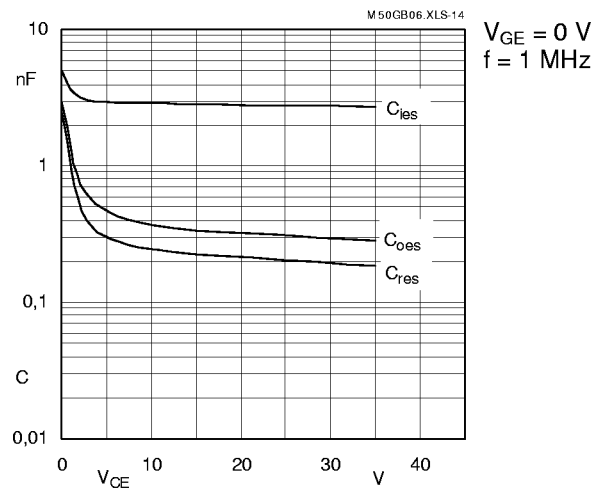


Fig. 14 Typ. capacitances vs.  $V_{CE}$

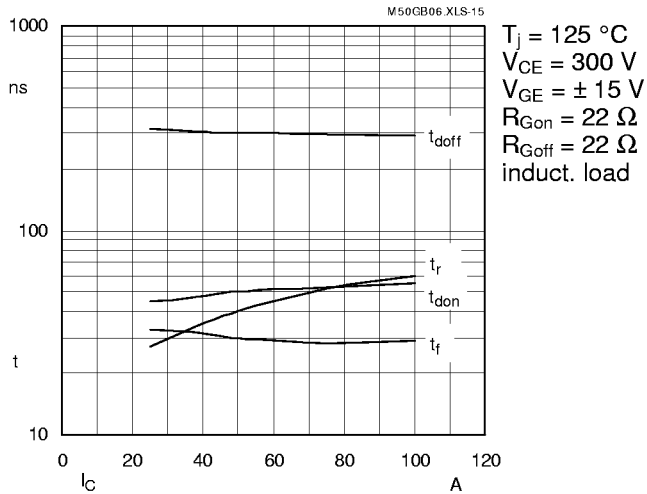


Fig. 15 Typ. switching times vs.  $I_C$

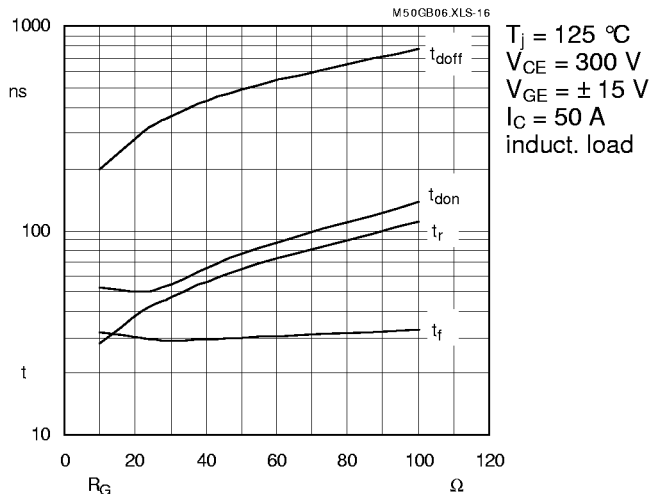


Fig. 16 Typ. switching times vs. gate resistor  $R_G$

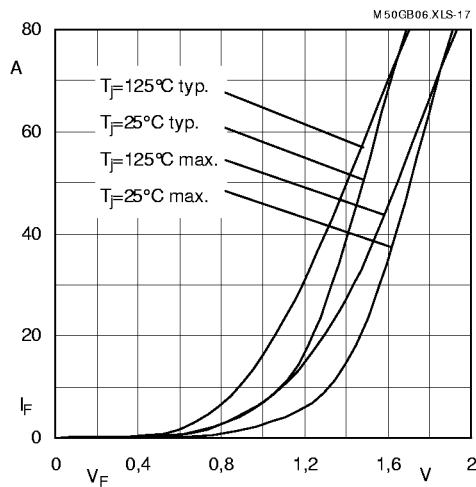


Fig. 17 Typ. CAL diode forward characteristic

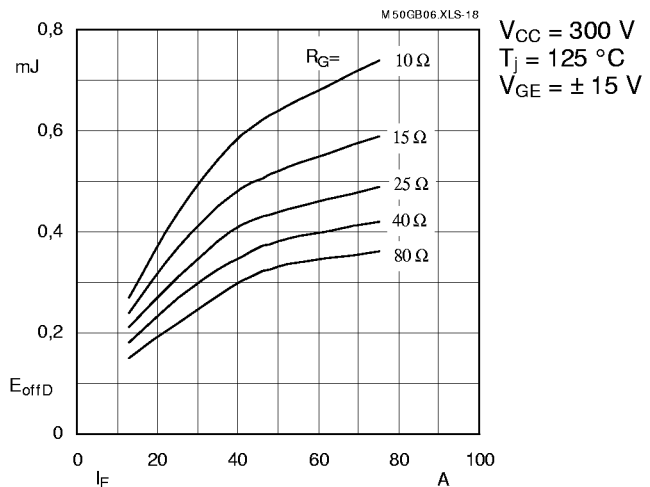


Fig. 18 Diode turn-off energy dissipation per pulse

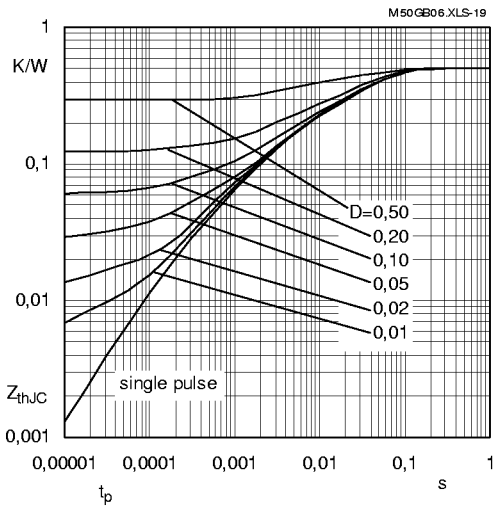


Fig. 19 Transient thermal impedance of IGBT  
 $Z_{thJC} = f(t_p)$ ;  $D = t_p / t_c = t_p \cdot f$

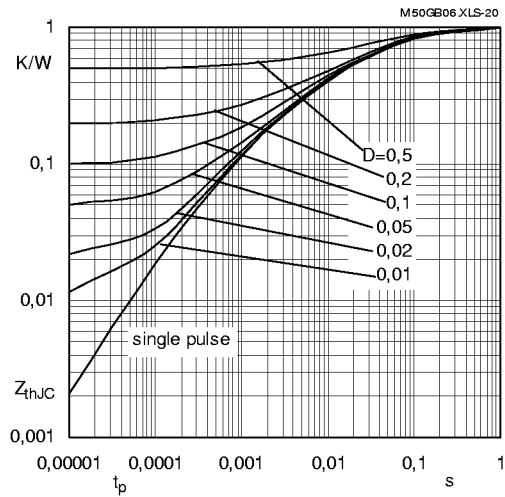
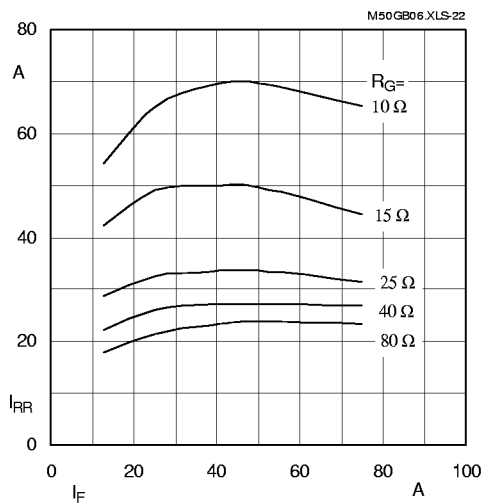
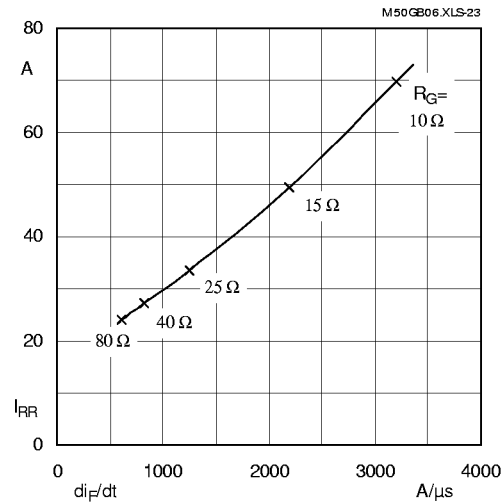


Fig. 20 Transient thermal impedance of inverse CAL diodes  
 $Z_{thJC} = f(t_p)$ ;  $D = t_p / t_c = t_p \cdot f$



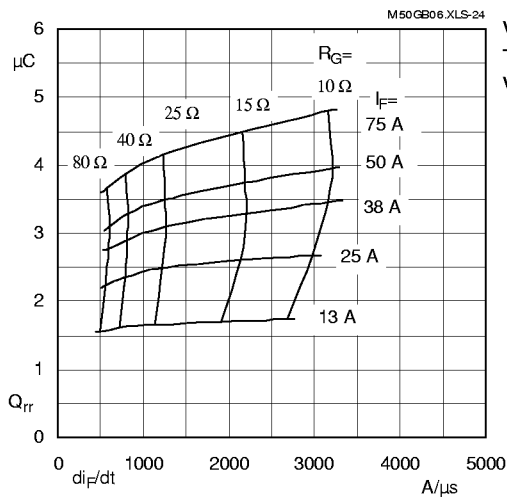
$V_{CC} = 300 \text{ V}$   
 $T_j = 125 \text{ °C}$   
 $V_{GE} = \pm 15 \text{ V}$

Fig. 22 Typ. CAL diode peak reverse recovery current  $I_{RR} = f(I_F; R_G)$



$V_{CC} = 300 \text{ V}$   
 $T_j = 125 \text{ °C}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_F = 50 \text{ A}$

Fig. 23 Typ. CAL diode peak reverse recovery current  $I_{RR} = f(di/dt)$



$V_{CC} = 300 \text{ V}$   
 $T_j = 125 \text{ °C}$   
 $V_{GE} = \pm 15 \text{ V}$

Fig. 24 Typ. CAL diode recovered charge